X-ray diffraction analysis of cold-worked Cu-Ni-Si and Cu-Ni-Si-Cr alloys by Rietveld method

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Received 11 May 2010; accepted 15 September 2010

Abstract: Cold worked and annealed supersaturated Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr alloys were studied. The microstructural parameters evolution, including crystallite size, root mean square strain and dislocation density was analyzed using Materials Analysis Using Diffraction software (MAUD). The parameters for both alloys have typical values of cold deformed and subsequently annealed copper based alloy. A net change of the crystallite size, root mean square strain and dislocation density values of the alloys aged at 450 °C for 2.5−3 h seems corresponding to the recovery and recrystallization processes. Addition of Cr as quaternary element did not lead to any drastic changes of post deformation or ageing microstructural parameters and hence of recovery-recrystallization kinetics.

Key words: Cu-Ni-Si alloy; microstructure; XRD line profile analysis; Materials Analysis Using Diffraction software

1 Introduction

Copper-base alloys present both high strength and high electrical conductivity required in electronic fields such as the framework of IC and connectors. Nowadays, Cu-Ni-Si alloys with small addition of other elements[1–8] have recently created a great interest. The thermo mechanical processing of these alloys is based on the plastic deformation by cold rolling and a subsequent ageing treatment. Even if a consequent documentation about the microstructural evolution as well as electrical and mechanical properties has been assembled yet, a manifest lack exists concerning the post deformation microstructural features like crystallite size, root mean square strain and dislocation density. It is well known that these parameters are the key factors controlling the microstructure evolution during annealing.

In this work, an extensive evaluation of the microstructural parameters after evolution upon cold rolling and ageing of supersaturated Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr (mass fraction, %) solid solutions was studied. Three cold plastic deformation levels, 70%, 90% and 95% (thickness reduction) were investigated and X-ray diffraction line profile analysis was carried out using JAVA-based Materials Analysis Using Diffraction (MAUD) 2 software[9–10].

2 Experimental

The Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr (mass fraction, %) alloys were provided by Le Bronze Industriel Firma (France) in the form of cylinders. Ingots (Parallelepipseds) were cut from the alloys and sealed in quartz capsules, then homogenized at 850 °C for 2 h and water quenched. The alloys were cold rolled to thickness reductions of 70%, 90% and 95%, and then aged at 450 °C in a time range from 0.5 to 9 h. Flat diffractometer specimens were prepared from Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr alloys. The X-ray diffraction patterns were recorded from the rolled and polished surface using BRUKERS D8 ADVANCE X-ray diffractometer operating at 40 kV, 40 mA with Cu \( K_a \) radiation. All the diffraction patterns were obtained by varying \( 2\theta \) from 15° to 88° with a scan step of 0.05. The time spent for collecting the data per step was 1.5 s.

3 Methodology

In this work, MAUD software which is based on a Rietveld refinement procedure was used[9–10]. This refinement procedure is fundamentally based on the use of analytical functions of pseudo-Voigt[11] and Pearson VII to model the whole experimental XRD patterns. A
diffraction pattern was simulated with all the fitting parameters (structural, microstructural, peak shape, width and background) and compared to the experimental data. The Rietveld’s refinement adopted an iterative least square procedure through minimization of the residual parameter. Capabilities and limitations of the Rietveld’s refinement from XRD data were widely discussed[12]. The Popa’s model of anisotropic size-strain broadening was used for the evaluation of the crystallite size and the microstrain values[13]. The direction dependent crystallite size \( R_h \) is developed in a convergent series of symmetrized spherical harmonics \( K_n^m(\Phi,\phi) \), as shown in Eq.(1).

\[
R_h = R_0 + R_1 K_1^1(\Phi,\phi) + R_2 K_2^1(\Phi,\phi) + R_3 K_3^1(\Phi,\phi) + \cdots
\]

where the coefficients \( R \) are refinable parameters; the symmetrized spherical harmonics are the combination of functions \( P_n^m(x)\cos m\phi \) \( (P_n^m(x) \) is the normalized Legendre function of argument \( x=\cos \Phi \); \( \Phi \) and \( \phi \) are the polar and azimuthal angles in an orthogonal coordinate system, respectively.

The \((h,k,l)\)-dependent strain Popa’s model for cubic symmetry is given as:

\[
\varepsilon_{hh}^2 = E_1(h^4 + k^4 + l^4) + 2E_2(h^2k^2 + k^2l^2 + l^2h^2)
\]

where coefficients \( E_1 \) and \( E_2 \) are the combination of terms like \( \delta_{ij}\varepsilon_{\text{str}} \). The relative change of interplanar distance produced by stress is given by \( \varepsilon_{hh} = -\Delta H / H \), in which \( H \) is one direction of the reciprocal lattice vector of unit vector \( h \). \( \varepsilon_{hh} \) represents the \((h, k, l)\)-dependent macroscopic strain, producing a peak shift.

In the calculation, the crystallite size is given by the diameter rather than the radius as expressed in Eq.(1) and the microstrain is the square root of \( \varepsilon_{hh}^2 \) parameter of the Popa’s model.

4 Results and discussion

Figure 1 presents the XRD pattern obtained from supersaturated Cu-2.65Ni-0.6Si alloy with the presence of three first characteristic diffraction peaks \((111)\), \((200)\) and \((220)\) of an FCC structured Cu matrix. There is no appearance of other peaks belonging to probable precipitate phases like \( \text{Ni}_2\text{Si} \) or \((\text{Cu, Ni})_2\text{Si}\). Figures 2 and 3 show the X-ray diffraction patterns of the cold rolled samples and the ones aged at 450 °C for different periods of time of the Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr alloys, respectively. The X-ray diffraction patterns of all the specimens were subjected to detailed microstructural studies using MAUD software, as evolved by plastic deformation and aging. These samples show higher lattice parameter values (listed in Table 1), revealing shifted reproduced peaks are mainly
caused by the solute effects rather than the deformation which does not change the parameters.

In case of deformed samples, Rietveld analysis required a correction due to the effect of texture\[14\−\[27\]. The parameter of gross preferential orientation has a value close to 0.6, which indicates the existence of a strong preferred orientation within the material.

The lattice parameters of the deformed solid solution seem also stable and are located at 3.612 and 3.613 Å, respectively. The higher value for the Cu-2.35Ni-0.6Si-0.6Cr solid solution seems due to the effect of Ni content and the addition of Cr. A similar effect of Cr was evoked in Ref.[16]. Indeed, it was evidenced that Cr (anti ferromagnetic element) increases the expansion coefficient and the lattice parameter.

Table 1 Lattice parameter of Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr alloys aged at 450 °C (Å±0.006)

<table>
<thead>
<tr>
<th>Alloy</th>
<th>Thickness reduction/%</th>
<th>Aging time</th>
<th>1 h</th>
<th>3 h</th>
<th>6 h</th>
<th>9 h</th>
</tr>
</thead>
<tbody>
<tr>
<td>Cu-2.65Ni-0.6Si</td>
<td>70%</td>
<td>3.617</td>
<td>3.612</td>
<td>3.611</td>
<td>3.611</td>
<td>3.612</td>
</tr>
<tr>
<td></td>
<td>90%</td>
<td>3.616</td>
<td>3.611</td>
<td>3.612</td>
<td>3.612</td>
<td>3.612</td>
</tr>
<tr>
<td></td>
<td>95%</td>
<td>3.615</td>
<td>3.612</td>
<td>3.612</td>
<td>3.612</td>
<td>3.613</td>
</tr>
<tr>
<td>Cu-2.35Ni-0.6Si-0.6Cr</td>
<td>70%</td>
<td>3.613</td>
<td>3.612</td>
<td>3.613</td>
<td>3.611</td>
<td>3.612</td>
</tr>
<tr>
<td></td>
<td>90%</td>
<td>3.616</td>
<td>3.613</td>
<td>3.616</td>
<td>3.614</td>
<td>3.613</td>
</tr>
<tr>
<td></td>
<td>95%</td>
<td>3.618</td>
<td>3.613</td>
<td>3.612</td>
<td>3.612</td>
<td>3.613</td>
</tr>
</tbody>
</table>

Figure 4 presents the evolution of the crystallite (coherent domains of diffraction) size versus deformation (cold rolling) level and annealing temperature for supersaturated Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr solid solutions.

For both alloys, a global decrease of the size of coherent domains with the deformation level and an increase with ageing time are observed. It is known that the more a metallic material deforms, the more the size of the coherent domains decreases, while an annealing tends to increase it by recovery-recrystallization mechanism on the contrary. For both alloys, the crystallite size values are comparable and a net change for around 2.5−3 h aging is depicted. This temperature range may correspond to a recovery-recrystallization time.

Figure 5 presents the evolution of the root mean square strain versus deformation (cold rolling) level and annealing temperature for supersaturated Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr solid solutions. The micro distortions in both alloys slightly increase with deformation level and decrease with ageing time. The drop of the micro distortions is less pronounced when the deformation level increases. Globally the micro distortions values are not different for both the studied alloys and the same net change aged for around 2.5−3 h is depicted in Fig.4.

Figure 6 presents the evolution of the dislocations density versus deformation (cold rolling) level and ageing time for supersaturated Cu-2.65Ni-0.6Si (a) and Cu-2.35Ni-0.6Si-0.6Cr (b) solid solutions.

From Fig.6, it is noticed that the dislocation density of Cu-2.35Ni-0.6Si-0.6Cr alloy is smaller than that of
The sizes of crystallites (coherent domains of diffraction) are in the same order between 289–619 Å for Cu-2.65Ni-0.6Si alloy and 325–696 Å for Cu-2.35Ni-0.6Si-0.6Cr alloy, respectively. Micro distortions seem to evolve in the same way and in a range of \((4.4\sim15.4)\times10^{-4}\) for Cu-2.65Ni-0.6Si and \((5.3\sim13.8)\times10^{-4}\) for Cu-2.35Ni-0.6Si-0.6Cr alloys, respectively.

The dislocation densities evolve in the same way for both alloys and their values are \((0.24\sim1.72)\times10^{11} \text{ cm}^{-2}\) for Cu-2.65Ni-0.6Si and \((0.28\sim1.31)\times10^{11} \text{ cm}^{-2}\) for Cu-2.35Ni-0.6Si-0.6Cr alloy, respectively.

It can be assumed that the chromium addition to ternary Cu-Ni-Si alloy does not yield significant changes of the post deformation and annealing microstructural parameters. As pointed out in Ref. [17], this element is rather added for metallurgical purposes to improve the plastic properties.

SAHU et al [18] reported the results of a similar study on Cu-15Ni-(5, 8, 13) Sn (mass fraction, %). It is noted that no indication on the deformation level of their alloys was given. The results are more or less similar to this research. However, it was determined that higher dislocation densities \((10^{-12} \text{ cm}^{-2})\) increased gradually with the increase of Sn content in the alloy. Maybe the...
plastic deformation method (hand filling) could introduce much higher dislocations into the material. Indeed, the substitution of Sn by Si and addition of Cr seem to lead to any drastic changes of post deformation and annealing microstructural parameters and hence of recovery-recrystallization kinetics.

The lattice parameter of supersaturated Cu-Ni-Sn alloys determined by SAHU et al[18] was around 3.621 Å. This value is higher than that of the present study, which may arise from a combined effect of substitution of Sn by Si and addition of Cr. The lattice parameter of Cu-xNi (x varying from 0 to 100%) was determined by ALILI et al[19]. The Cu-Ni solid solution was found to obey Végard's law and the lattice parameter decreased from 3.609 to 3.601 Å when the Ni content increased from 5% to 15%. Hence, the addition of Sn, Si and Cr elements increased the lattice parameter of Cu-Ni solid solution.

The crystallite size values of deformed alloys determined by SAHU et al[18] were lower than those of the present study (100 Å and 289–325 Å, respectively). For the annealed alloys, the values are more or less comparable (450-750 Å and 619-696 Å, respectively). Micro distortion values determined by SAHU et al[18] are lower than those of the present study (15.4×10⁻⁴ and 60×10⁻⁴, respectively).

The dislocation densities of the deformed Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr alloys were in range of (0.21–1.72)×10¹¹ cm⁻² while those of Cu-Ni-Sn studied by SAHU et al[18] and Cu-Ni-Zn[20] were around 8×10¹¹ and 18×10¹¹ cm⁻², respectively. If it is assumed that the amount of deformation is the same, these differences may be due to the segregation difference of elements Sn, Si and Cr in grain boundaries in one hand and clustering in other hand, which determines the dislocation mobility.

The net change depicted in Figs.4 and 6 is in agreement with the results in Ref.[2], in which around 80% of the maximum conductivity was restored between 1 and 4 h of ageing depending on the initial treatment of the alloy. It is evidenced a slow rise in the electrical conductivity of the alloy aged for up to 12 h and then a nearly constant value with further increase in ageing time up to 35 h.

Several works[3] showed that the hardness of the aged Cu-Ni-Si alloys was increased by cold rolling after solution treatment. This phenomenon is considered to result from preferential precipitation in high density of dislocations introduced by cold rolling. The finely dispersed precipitates which are responsible for the high performance are identified as δ-Ni₂Si[21]. Ageing at 450 °C induces combined precipitation and recovery-recrystallization reactions that are similar to the third part of the scheme proposed by HORNBOGEN and KÖSTER[22], in which precipitation occurs before recrystallization. The δ-Ni₂Si particles precipitate continuously and control the recovery rate. Subsequent discontinuous precipitation of Ni₂Si occurs on migrating high angle grain boundaries.

5 Conclusions

1) Cu-2.65Ni-0.6Si and Cu-2.35Ni-0.6Si-0.6Cr alloys were cold deformed and subsequently aged at 450 °C for a time period ranging from 0.5 to 9 h. The crystallite size, root mean square strain and dislocation density are typical parameters.

2) A net change of the crystallite size, root mean square strain and dislocation density values of aging at 450 °C for 2.5–3 h seems to correspond to the recovery and recrystallization processes.

3) Addition of Cr as quaternary element does not lead to any drastic changes of post deformation and aging microstructural parameters and hence of recovery-recrystallization kinetics.

Acknowledgments

The authors wish to heartily thank Mr. BRUNO CAUWE from Le Bronze Industriel company, France, for kindly providing the materials, Pr. PAWEL ZIEBA from the Polish Academy of Sciences, Cracow, Poland, for his help and assistance and Pr. Z. K. HEIBA from Faculty of Sciences, Ain Shams University, Cairo, Egypt, for manuscript improvement.

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冷加工 Cu-Ni-Si 和 Cu-Ni-Si-Cr 合金的分析

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摘要：研究冷加工和退火处理的过饱和 Cu-2.65Ni-0.6Si 和 Cu-2.35Ni-0.6Si-0.6Cr 合金。采用软件 MAUD 分析其显微组织参数的演变，包括晶粒尺寸、应变均方根和位错密度等。结果表明，冷加工和退火处理的两种合金的显微组织参数其特定值。在 450 ℃时效 2.5~3 h 的合金，其晶粒尺寸、应变均方根和位错密度等参数的净变化量与回复和再结晶过程相关。Cr 作为第四组元添加到合金中没有明显改变形变和时效处理后合金的结构参数，因此也不影响合金的回复再结晶动力学。

关键词：Cu-Ni-Si 合金；显微组织；XRDLPA；Materials Analysis Using Diffraction 软件

(Edited by FANG Jing-hua)